

Model Name: T650QVN01.2

Issue Date: 2012/12/06

(*)Preliminary Specifications()Final Specifications

Customer Signature	Date	AUO	Date			
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0. Record of Revision

Version	Date	Page	Description
0.0	2012/11/26		First release
0.1	2012/12/06		Revise Mechanical drawing& product weight



1. General Description

This specification applies to the 65 inch Color TFT-LCD Module T650QVN01.2. This LCD module has a TFT active matrix type liquid crystal panel 3840x2160 pixels, and diagonal size of 65 inch. This module supports 3840x2160 mode. Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the brightness of the sub-pixel color is determined with a 10-bit gray scale signal for each dot.

The T650QVN01.2 has been designed to apply the 10-bit 16 Lanes V by one interface method. It is intended to support displays where high brightness, wide viewing angle, high color saturation, and high color depth are very important.

* General Information

Items	Specification	Unit	Note
Active Screen Size	65	inch	
Display Area	1428.48(H) x 803.52(V)	mm	
Outline Dimension	1454.3(H) x 831.5 (V) x 18(D)	mm	D: front bezel to T-con cover
Driver Element	a-Si TFT active matrix		
Bezel Opening	1434.5 (H) x 809.6 (V)	mm	
Display Colors	10 bit, 16.7M	Colors	
Number of Pixels	3840x2160	Pixel	
Pixel Pitch	0.372 (H) x 0.372(W)	mm	
Pixel Arrangement	RGB vertical stripe		
Display Operation Mode	Normally Black		
Surface Treatment	Glare		
Rotate Function	Unachievable		Note 1
Display Orientation	Signal input with "ABC"		Note 2

Note 1: Rotate Function refers to LCD display could be able to rotate. Note 2: LCD display as below illustrated when signal input with "ABC".

Rear side Front side

ABC

Tcon board



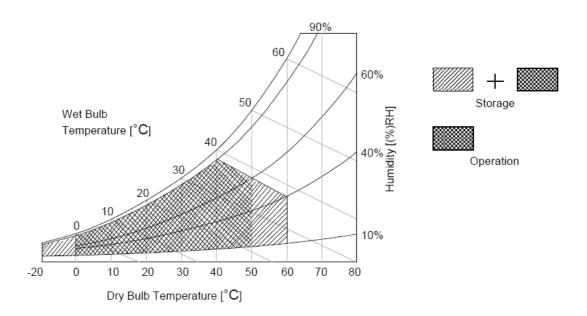
2. Absolute Maximum Ratings

The followings are maximum values which, if exceeded, may cause faulty operation or damage to the unit

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vcc	-0.3	14	[Volt]	Note 1
Input Voltage of Signal	Vin	-0.3	3.6	[Volt]	Note 1
Operating Temperature	TOP	0	+50	[°C]	Note 2
Operating Humidity	HOP	10	90	[%RH]	Note 2
Storage Temperature	TST	-20	+60	[°C]	Note 2
Storage Humidity	HST	10	90	[%RH]	Note 2
Panel Surface Temperature	PST		65	[°C]	Note 3

Note 1: Duration:50 msec.

The relative humidity must not exceed 90% non-condensing at temperatures of 40° C or less. At temperatures greater than 40° C, the wet bulb temperature must not exceed 39° C.





3. Electrical Specification

The T650QVN01.1 has one power inputs, which is employed to power the LCD electronics and to drive the TFT array and liquid crystal.

3.1 Electrical Characteristics

3.1.1: DC Characteristics

	Davamatav	Cyronhod		Value		l la!t	Note
	Parameter	Symbol	Min.	Тур.	Max	Unit	Note
LCD							
Power Supp	ply Input Voltage	V_{DD}	10.8	12	13.2	V _{DC}	
Power Supp	ply Input Current	I _{DD}		TBD	TBD	Α	1
Power Cons	sumption	Pc		TBD	TBD	Watt	1
Inrush Curr	ent	I _{RUSH}		-	TBD	Α	2
Permissible	Ripple of Power Supply Input Voltage	V_{RP}		1	V _{DD} * 5%	mV_{pk-pk}	3
	Input Differential Voltage	V _{ID}	100			mV_{DC}	4
V by One	Differential Input High Threshold Voltage	V_{TH}	+50			mV_{DC}	4
Interface	Differential Input Low Threshold Voltage	V_{TL}			-50	mV_{DC}	4
	Input Common Mode Voltage	V _{ICM}		0.82		V_{DC}	4
CMOS	Input High Threshold Voltage	V _{IH} (High)	2.4		3.3	V_{DC}	5
Interface	Input Low Threshold Voltage	V _{IL} (Low)	0		0.6	V_{DC}	5
Backlight P	P_{BL}	TBD	239	254	Watt		
Life time (M	ITTF)		30000			Hour	6,7

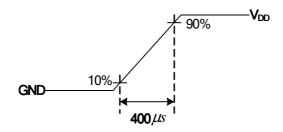


3.1.2: AC Characteristics

	Davametar	Cymbol		Value		Unit	Note
	Parameter	Symbol	Min.	Тур.	Max	Uffil	Note
	VRXINP/N input each bit Period	T _{RRIP}	413		505	ps	8bit 8
	VITALINI /N IIIput each bit i enou	(UI)	310		379	ps	10bit 8
	CDR lock time(CDR training)	T _{RLCK0}			1.0	ms	8
V-by-one Interface				30720		UI	8bit 8
	ALN Training	T _{RALN}		40960		UI	10bit 8
	PDX active to hot plug enable	T _{RHPD0}			1.0	us	8
	Intra-pair skew	T _{INTRA}			0.3	UI	9
	Inter-pair skew	T _{INTER}			5	UI	10
	SCL clock frequency	F _{SCL}	0		400	KHZ	
	I2C clock high level	T _{SCHi}	0.6			us	
I2C	I2C clock low level	T _{SCLo}	1.2			us	
	I2C data setup time	T_{SDS}	100		-	ns	
Interface	I2C data hold time	T _{SDH}	0		900	ns	
	SDA and SCL rise time	T_R			1000	ns	
	SDA and SCL fall time	T_F			300	ns	

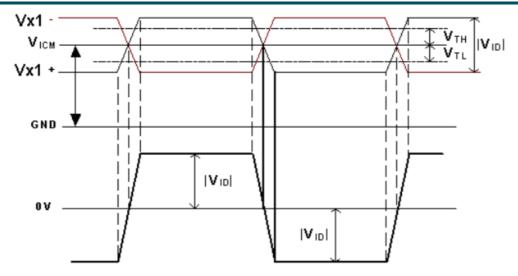
Note:

- 1. V_{DD} = 12.0V, Fv = 120Hz, Fclk= = 78.125MHz., 25 $^{\circ}$ C, Test Pattern : White Pattern >> refer to "Section:3.3 Signal Timing Specification, Typical timing"
- 2. Measurement condition: Rising time = 400us

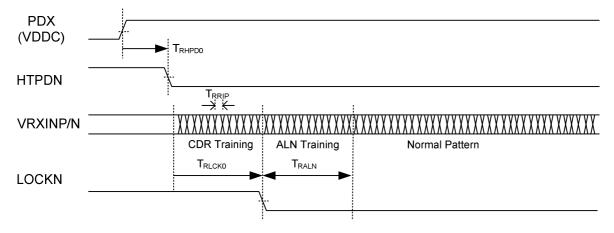


- 3. Test Condition:
 - (1) The measure point of V_{RP} is in LCM side after connecting the System Board and LCM.
 - (2) Under Max. Input current spec. condition.
- **4.** $V_{ICM} = 0.82V$

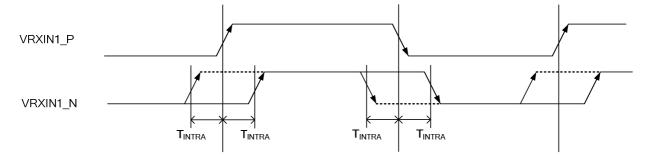




- **5.** The measure points of V_{IH} and V_{IL} are in LCM side after connecting the System Board and LCM.
- **6.** The relative humidity must not exceed 80% non-condensing at temperatures of 40° C or less. At temperatures greater than 40° C, the wet bulb temperature must not exceed 39° C. When operate at low temperatures, the brightness of LED will drop and the life time of LED will be reduced.
- 7. The lifetime (MTTF) is defined as the time which luminance of LED is 50% compared to its original value. [Operating condition: Continuous operating at $Ta = 25\pm2^{\circ}C$]
- 8. V-by-one Receiver start up timing waveform

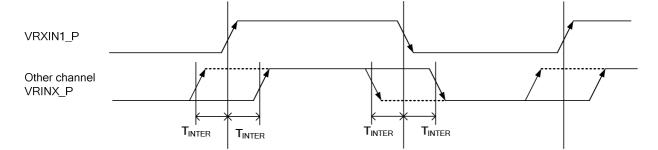


9. V-by-one Intra-pair Skew





10. V-by-one Inter-pair Skew





3.2 Interface Connections

• LCD connector: FI-RE51S-HF (JAE, V-by-One 51pin connector)

PIN	Symbol	Description	PIN	Symbol	Description
1	NC	AUO Internal Use Only	26	GND	CML Ground
2	NC	AUO Internal Use Only	27	Rx2n	V-by-One HS Data Lane 2
3	NC	AUO Internal Use Only	28	Rx2p	V-by-One HS Data Lane 2
4	NC	AUO Internal Use Only	29	GND	CML Ground
5	NC	AUO Internal Use Only	30	GND	CML Ground
6	NC	AUO Internal Use Only	31	Rx3n	V-by-One HS Data Lane 3
7	NC	AUO Internal Use Only	32	Rx3p	V-by-One HS Data Lane 3
8	NC	AUO Internal Use Only	33	GND	CML Ground
9	NC	AUO Internal Use Only	34	GND	CML Ground
10	NC	AUO Internal Use Only	35	Rx4n	V-by-One HS Data Lane 4
11	GND	Ground	36	Rx4p	V-by-One HS Data Lane 4
12	GND	Ground	37	GND	CML Ground
13	GND	Ground	38	GND	CML Ground
14	GND	Ground	39	Rx5n	V-by-One HS Data Lane 5
15	GND	Ground	40	Rx5p	V-by-One HS Data Lane 5
16	HTPDN	Hot plug detect	41	GND	CML Ground
17	LOCKN	Lock detect	42	GND	CML Ground
18	GND	CML Ground	43	Rx6n	V-by-One HS Data Lane 6
19	Rx0n	V-by-One HS Data Lane 0	44	Rx6p	V-by-One HS Data Lane 6
20	Rx0p	V-by-One HS Data Lane 0	45	GND	CML Ground
21	GND	CML Ground	46	GND	CML Ground
22	GND	CML Ground	47	Rx7n	V-by-One HS Data Lane 7
23	Rx1n	V-by-One HS Data Lane 1	48	Rx7p	V-by-One HS Data Lane 7
24	Rx1p	V-by-One HS Data Lane 1	49	GND	CML Ground
25	GND	CML Ground	50	NC	AUO Internal Use Only
			51	NC	AUO Internal Use Only



● LCD V-by-One connector: FI-RE41S-HF (JAE, V-by-One 41pin connector)

PIN	Symbol	Description	PIN	Symbol	Description
1	GND	Ground	21	Rx11n	V-by-One HS Data Lane 11
2	GND	Ground	22	Rx11p	V-by-One HS Data Lane 11
3	GND	Ground	23	GND	CML Ground
4	GND	Ground	24	GND	CML Ground
5	GND	Ground	25	Rx12n	V-by-One HS Data Lane 12
6	NC	AUO Internal Use Only	26	Rx12p	V-by-One HS Data Lane 12
7	NC	AUO Internal Use Only	27	GND	CML Ground
8	GND	CML Ground	28	GND	CML Ground
9	Rx8n	V-by-One HS Data Lane 8	29	Rx13n	V-by-One HS Data Lane 13
10	Rx8p	V-by-One HS Data Lane 8		Rx13p	V-by-One HS Data Lane 13
11	GND	CML Ground	31	GND	CML Ground
12	GND	CML Ground	32	GND	CML Ground
13	Rx9n	V-by-One HS Data Lane 9	33	Rx14n	V-by-One HS Data Lane 14
14	Rx9p	V-by-One HS Data Lane 9	34	Rx14p	V-by-One HS Data Lane 14
15	GND	CML Ground	35	GND	CML Ground
16	GND	CML Ground	36	GND	CML Ground
17	Rx10n	V-by-One HS Data Lane 10	37	Rx15n	V-by-One HS Data Lane 15
18	Rx10p	V-by-One HS Data Lane 10	38	Rx15p	V-by-One HS Data Lane 15
19	GND	CML Ground	39	GND	CML Ground
20	GND	CML Ground	40	NC	AUO Internal Use Only
			41	NC	AUO Internal Use Only

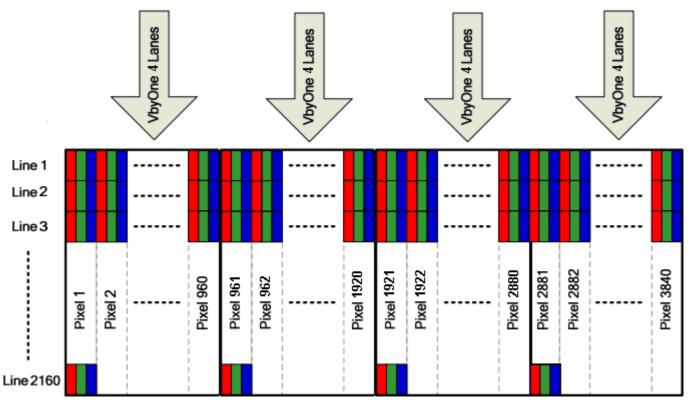
LCD Power connector:

Power CN(12pin): SM12B-PASS-TBT (JST)

PIN	Symbol	Description
1	PWR Power 12V IN	PWR Power 12V IN
2	PWR Power 12V IN	PWR Power 12V IN
3	PWR Power 12V IN	PWR Power 12V IN
4	PWR Power 12V IN	PWR Power 12V IN
5	PWR Power 12V IN	PWR Power 12V IN
6	NC	NC Pin
7	NC	NC Pin
8	GND	Ground
9	GND	Ground
10	GND	Ground
11	GND	Ground
12	GND	Ground



4K2K Input Data Format : 2D mode



Note: Normal pixel data mapping

2D Mode Pixel Mapping:

Pixel No		Pixel 1			Pixel 2	!		Pixel 3	3	^		F	Pixel 384	0
Line 1	R1	G1	B1	R2	G2	B2	R3	G3	В3	R4	~	R3840	G3840	B3840
Line 2	R1	G1	B1	R2	G2	B2	R3	G3	В3	R4	~	R3840	G3840	B3840
Line 3	R1	G1	B1	R2	G2	B2	R3	G3	В3	R4	~	R3840	G3840	B3840
Line 4	R1	G1	B1	R2	G2	B2	R3	G3	В3	R4	~	R3840	G3840	B3840
Line 5	R1	G1	B1	R2	G2	B2	R3	G3	В3	R4	~	R3840	G3840	B3840
Line 6	R1	G1	B1	R2	G2	B2	R3	G3	В3	R4	~	R3840	G3840	B3840
:	:	:	:	:	:	:	:	:		:	~	:	:	:
Line 2158	R1	G1	B1	R2	G2	B2	R3	G3	В3	R4	~	R3840	G3840	B3840
Line 2159	R1	G1	B1	R2	G2	B2	R3	G3	В3	R4	~	R3840	G3840	B3840
Line 2160	R1	G1	B1	R2	G2	B2	R3	G3	В3	R4	~	R3840	G3840	B3840



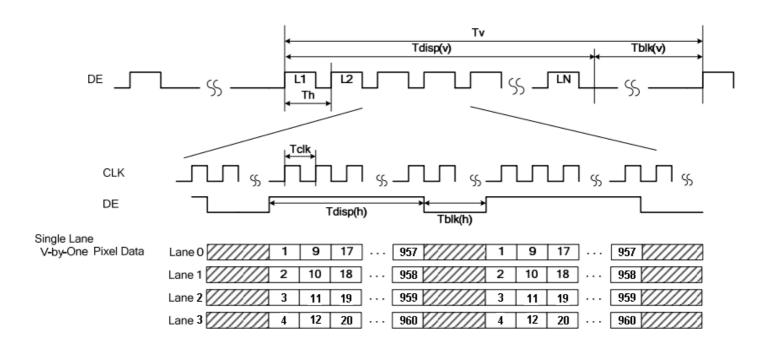
3.3 Signal Timing Specification

This is the signal timing required at the input of the user connector. All of the interface signal timing should be satisfied with the following specifications for its proper operation.

Timing Table (DE only Mode)

Signal	Item	Symbol	Min. Typ. Max			Unit
	Period	Tv	2180	2200	2692	Th
Vertical Section	Active	Tdisp (v)		2160		Th
	Blanking	Tblk (v)	20	40	532	Th
	Period	Th	280	290	354	Tclk
Horizontal Section	Active	Tdisp (h)		240		Tclk
	Blanking	Tblk (h)	40	50	114	Tclk
Clock	Frequency	Fclk=1/Tclk	66	76.56	78.125	MHz
Vertical Frequency	Frequency	Fv	98	120	122	Hz
Horizontal Frequency	Frequency	Fh	240	264	278.4	KHz

3.4 Signal Timing Waveforms





3.5 Color Input Data Reference

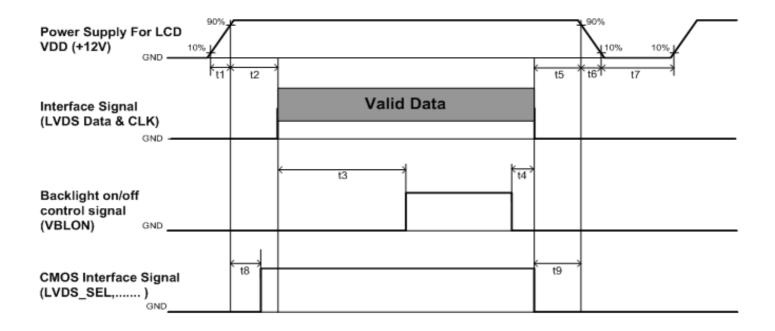
The brightness of each primary color (red, green and blue) is based on the 10 bit gray scale data input for the color; the higher the binary input, the brighter the color. The table below provides a reference for color versus data input.

COLOR DATA REFERENCE

														In	put	Col	or E	Data	l												
	Color					RE	D								(GRE	ΞEN	1								BL	UE				
	30.01	MS	B					1		L	SB	MS	SB							LS	SB	MS	В							L	SB
		R9	R8	R7	R6	R5	R4	R3	R2	R1	R0	G9	G8	G7	G6	G5	G4	G3	G2	G1	G0	B9	B8	В7	B6	B5	B4	ВЗ	B2	B1	B0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1023)	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1023)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0
	Blue(1023)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1
Color	Cyan	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	RED(000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED(001)	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R																															
	RED(1022)	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED(1023)	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN(000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN(001)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
G)																								
	GREEN(1022)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0
	GREEN(1023)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0
	BLUE(000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	BLUE(001)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	BLUE(1022)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0
В	BLUE(1023)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1



3.6 Power Sequence for LCD (TBD)



Darameter		Lloit		
Parameter	Min.	Type.	Max.	Unit
t1	0.4		30	ms
t2	0.1		50	ms
t3	450			ms
t4	0*1			ms
t5	0			ms
t6			*2	ms
t7	500			ms
t8	10*3		50	ms
t9	0			ms

Note:

- (1) t4=0 : concern for residual pattern before BLU turn off.
- (2) t6 : voltage of VDD must decay smoothly after power-off. (customer system decide this value)
- (3) When CMOS Interface signal is N.C. (no connection), opened in Transmitted end, t8 timing spec can be negligible



3.7 Backlight Specification (independent driver board)

The backlight unit contains 8 pcs light bar.

3.7.1 Light bar Driven Condition

		Symbol	Condition												
No	Item		Vi	Vin (volt)		PDIM (%)	Te	mpera (°C)		Description		Specific	ation		Note
			Min Typ Max		Max	Тур	Min Typ Max		Max		Min	Тур	Max	unit	
1	Input voltage	Vin				100	_	25	-	DC input voltage Vin_typ ±10%		24	26.4	Volt	
2	Input current	Iin	-	24	_	100	_	25	-	Input current of 100% brightness Iin_typ ±5%		TBD	TBD	A	
3	Input inrush current	Irush	21.6	24	26.4	100	-	25	-	Input inrush current	1	-	TBD	A	
3	Input voltage protection	IVP	/-/	<i>^</i>	-	_	-	25	-	Input Protection voltage is Vintyp Recover voltage	17		20	Volt	
	-	Dpwm 21.6 24 26.4 25 E_PWM duty ratio of Max brightness			100	_	%								
	External PWM	Dpwm	21.6	24	26.4		_	25		E_PWM duty ratio of Min brightness		0	_	%	*1
4	dimming duty ratio and voltage	Vburst	21.6	24	26.4)]	_	25		E_PWM voltage of Low (off) level	-0.3	_	0.8	Volt	
	(PDIM Pin)	Vburst	21.6	24	26.4	//_	_	25		E_PWM voltage of High (on) level	2	-	3.3	Volt	
	/,	Fpwm	21.6	24	4 26.4 _		()	25		E_PWM frequency	90	_	240	Hz	
5	On/Off control	VBLON	21.6	24	26.4	(+		25	- 1	V _{BLON} voltage of Low level (Enable Off)	-0.3	-	0.8	Volt	
	voltage	V_{BLON}	21.6	24	26.4		2/	25))	V_{BLON} voltage of High level, or pin open (Enable On)	2	-	3.3	Volt	
6	Output operating voltage	Vo	21.6	24	26.4	100		25	/41	Output operating voltage: Vo Vo=LED/String*LED Vf(min, typ,max),	58	65	70	Volt	*2
7	Output current	Iomax	21.6	24	26.4	100	ı	25		Output current of Max brightness for one channel Jorange=Iotyp +/- 5%	109.25	115	120.75	mΑ	
8	Output Current ripple	Iorp	21.6	24	26.4	100	()	25		Output Current ripple Iop-p/Iorms		•	10	%	
9	Delta Vf	Iorp	21.6	24	26.4	100	-)	25	-	Max delta Vf of LED string It's depended on LED binning.	-	-	1.8	V	
10	Operation temperature	Тор	_	24	-		2/	_		Room temp of Driving board operation	-10	25	70	°C	
11	Storage temperature	Tst	_	24	_	-		> {((-)	Driving board PCBA is put in chamber	-30	_	80	°C	

^{*1.} IF External PWM function includes 5% dimming function. Judge condition is shown below:
1.) Backlight module must be lighted ON normally.

All protection function must operate normally.
 Uniformity and flicker could NOT be guaranteed!

^{*2.} LED/String=1pcs, LED Vf(min, typ,max)=5.8V, 6.5V, 7V



3.7.2 Input Pin Assignment

CN1: CI0114M1HRL-NH (Cvilux) or compatible

Pin No	Symbol	Description
1	VDDB	Operating Voltage Supply, +24V DC regulated
2	VDDB	Operating Voltage Supply, +24V DC regulated
3	VDDB	Operating Voltage Supply, +24V DC regulated
4	VDDB	Operating Voltage Supply, +24V DC regulated
5	VDDB	Operating Voltage Supply, +24V DC regulated
6	BLGND	Ground and Current Return
7	BLGND	Ground and Current Return
8	BLGND	Ground and Current Return
9	BLGND	Ground and Current Return
10//	BLGND	Ground and Current Return
11 (DET	BLU status detection: Normal: 0~0.8V; Abnormal: Open collector (Recommend Pull high R > 10K, VDD = 3.3V)
12	VBLON	BL On-Off: High/Open (2.0V~5.5V) for BL On , Low (GND) for off
13	NC>(())	NA
14	External PWM(PDIM) (*)	External PWM (0%~100%)

(Note*) PWM Dimming range:



IF External PWM function less than 5% dimming ratio, Judge condition as below:

- (1)Backlight module must be lighted ON normally.
- (2)All protection function must work normally.
- (3)Uniformity and flicker could NOT be guaranteed

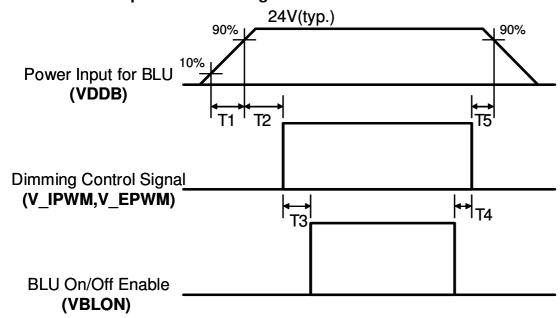


CN2: CI0112M1HRL-NH (Cvilux) or compatible

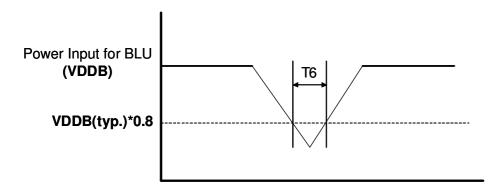
Pin No	Symbol	Description
1	1	VDDB
2	2	VDDB
3	3	VDDB
4	4	VDDB
5	5	VDDB
6	6//	BLGND
7	7//	BLGND
8	8	BLGND
9	9	BLGND
10	10	BLGND
11 🌽	NC	NA NA
12	NC 众	NA NA



3.7.3 Power Sequence for Backlight



Dip condition for Inverter



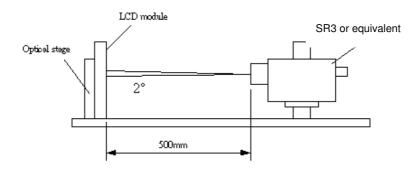
Dovernotes		Units		
Parameter	Min	Тур	Max	Units
T1	20	-	-	ms
T2	500	-	-	ms
Т3	250	-	-	ms
T4	0	-	-	ms
T5	1	-	-	ms
T6	-	-	10	ms



4. Optical Specification

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 45 minutes in a dark environment at 25 °C. The values specified are at an approximate distance 50cm from the LCD surface at a viewing angle of φ and θ equal to 0 °.

Fig.1 presents additional information concerning the measurement equipment and method.



Davamatav	Cumala al		Values		l lm!t	Natas
Parameter	Symbol	Min.	Тур.	Max	Unit	Notes
Contrast Ratio	CR	3200	4000			1
Surface Luminance (White)	L _{WH}	280	350		cd/m ²	2
Luminance Variation	δ _{WHITE(9P)}			1.33		3
Response Time (G to G)	Тү		6.5		Ms	4
Color Gamut	NTSC		72		%	
Color Coordinates (TBD)						
Red	R_X		0.630			
	R_Y		0.340			
Green	G _X		0.340			
	G_Y	T 0.00	0.620	T 0.00		
Blue	B _X	Тур0.03	0.150	Тур.+0.03		
	B _Y		0.040			
White	W _X		0.280			
	W_{Y}		0.290			
Viewing Angle						5
x axis, right(φ=0°)	θ_{r}		89		degree	
x axis, left(φ=180°)	θι		89		degree	
y axis, up(φ=90°)	θ_{u}		89		degree	
y axis, down (φ=270°)	$\theta_{\sf d}$		89		degree	



Note:

1. Contrast Ratio (CR) is defined mathematically as:

Contrast Ratio=
$$\frac{\text{Surface Luminance of L}_{\text{on5}}}{\text{Surface Luminance of L}_{\text{off5}}}$$

- Surface luminance is luminance value at point 5 across the LCD surface 50cm from the surface with all pixels displaying white. From more information see FIG 2. LED current I_F = typical value (without driver board), LED input VDDB =24V, I_{DDB}. = Typical value (with driver board), L_{WH}=Lon5 where Lon5 is the luminance with all pixels displaying white at center 5 location.
- 3. The variation in surface luminance, δ WHITE is defined (center of Screen) as: $\delta_{WHITE(9P)} = Maximum(L_{on1}, L_{on2},...,L_{on9}) / Minimum(L_{on1}, L_{on2},...L_{on9})$
- 4. Response time T_{γ} is the average time required for display transition by switching the input signal for five luminance ratio (0%,25%,50%,75%,100% brightness matrix) and is based on F_{ν} =120Hz to optimize.

Measured		Target									
Response Time		0%	25%	50%	75%	100%					
	0%		0% to 25%	0% to 50%	0% to 75%	0% to 100%					
	25%	25% to 0%		25% to 50%	25% to 75%	25% to 100%					
Start	50%	50% to 0%	50% to 25%		50% to 75%	50% to 100%					
	75%	75% to 0%	75% to 25%	75% to 50%		75% to 100%					
	100%	100% to 0%	100% to 25%	100% to 50%	100% to 75%						

 T_{γ} is determined by 10% to 90% brightness difference of rising or falling period. (As illustrated)

The response time is defined as the following figure and shall be measured by switching the input signal for "any level of gray(bright)" and "any level of gray(dark)".

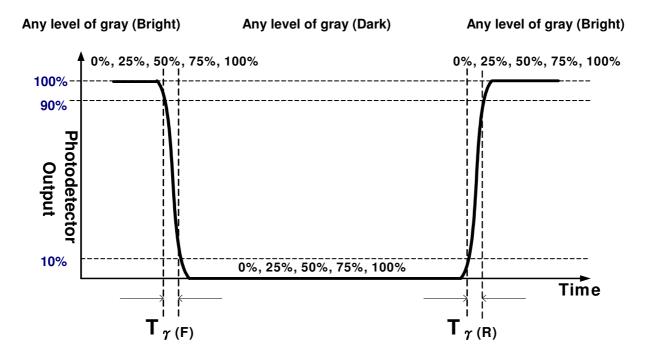
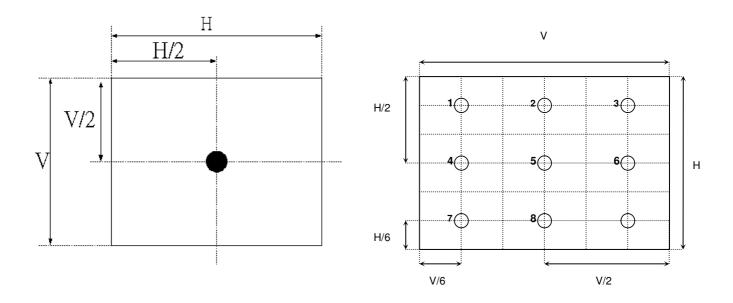


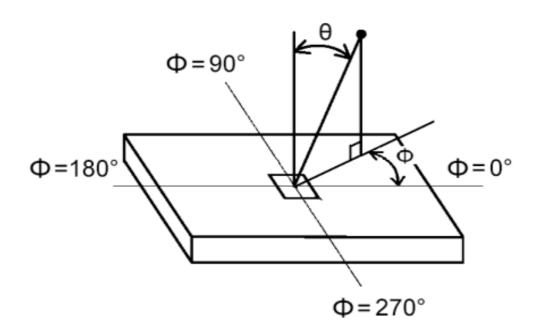


FIG. 2 Luminance



5. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG3.

FIG.3 Viewing Angle





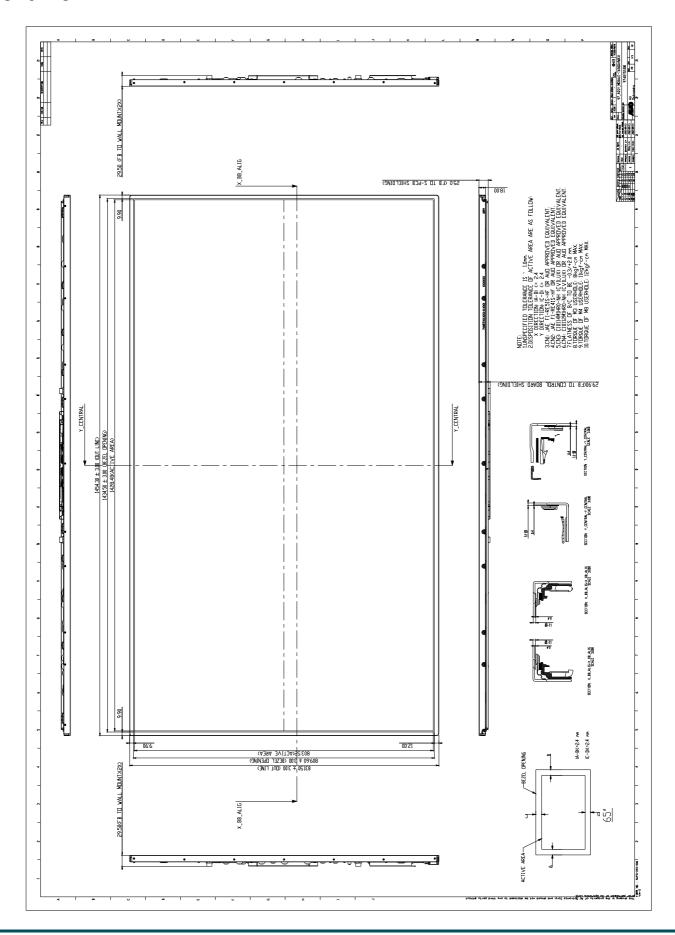
5. Mechanical Characteristics

The contents provide general mechanical characteristics for the model T650QVN01.1. In addition the figures in the next page are detailed mechanical drawing of the LCD.

It	tem	Dimension	Unit	Note
	Horizontal	1454.3	mm	
Outling Dimension	Vertical	831.5	mm	
Outline Dimension	Depth (Dmin)	18	mm	front bezel to T-con cover
	Depth (Dmax)	29.3	mm	to T-con cover
Weight	25200 (T	BD)	g	

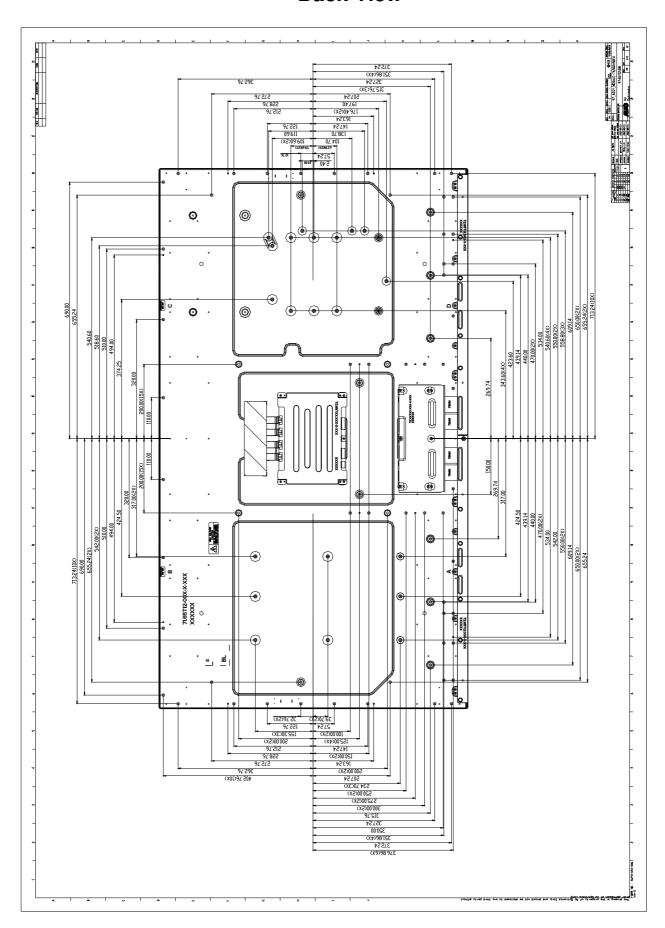


Front View

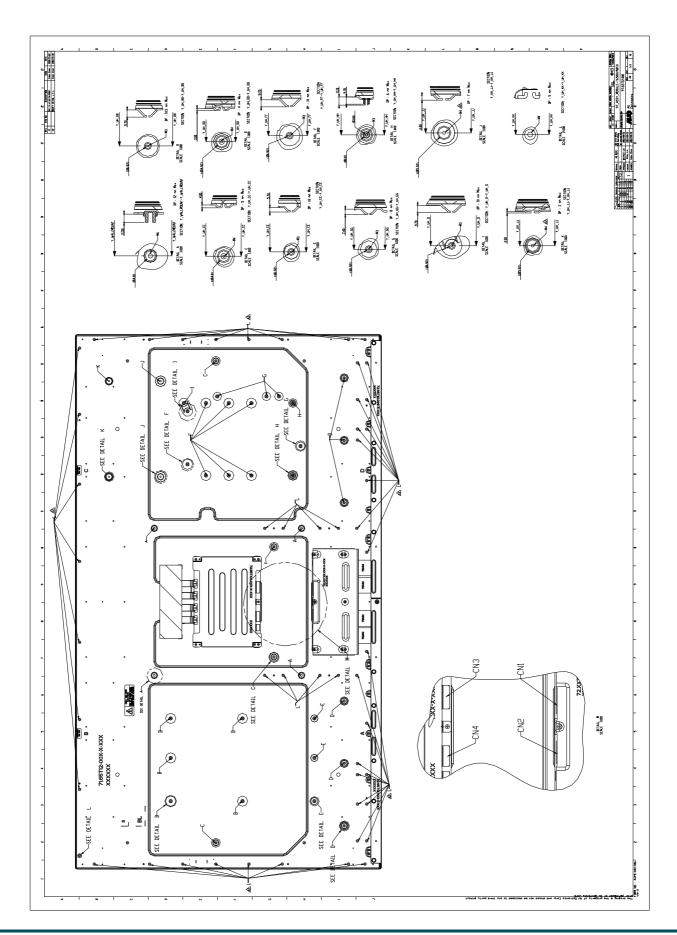




Back View









6. Reliability Test Items

	Test Item	Q'ty	Condition
1	High temperature storage test	3	60°C, 300hrs
2	2 Low temperature storage test		-20℃, 300hrs
3	High temperature operation test	3	50°C, 300hrs
4	Low temperature operation test	3	-5℃, 300hrs
5	Vibration test (With carton)	5/carton	Random wave (1.05Grms 10~200Hz) Duration: X,Y,Z 10min per axes
6	6 Drop test (With carton)		surround four flats, 150 mm bottom flat two times, 254 mm



7. International Standard

7.1 Safety

- (1) UL 60950-1, UL 60065; Standard for Safety of Information Technology Equipment Including electrical Business Equipment.
- (2) IEC 60950-1: 2001, IEC 60065:2001; Standard for Safety of International Electrotechnical Commission
- (3) EN 60950 : 2001+A11, EN 60065:2002+A1:2006; European Committee for Electrotechnical Standardization (CENELEC), EUROPEAN STANDARD for Safety of Information Technology Equipment Including Electrical Business Equipment.

7.2 EMC

- (1) ANSI C63.4 "Methods of Measurement of Radio-Noise Emissions from Low-Voltage Electrical and Electrical Equipment in the Range of 9kHz to 40GHz. "American National standards Institute(ANSI), 1992
- (2) C.I.S.P.R "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." International Special committee on Radio Interference.
- (3) EN 55022 "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." European Committee for Electrotechnical Standardization. (CENELEC), 1998

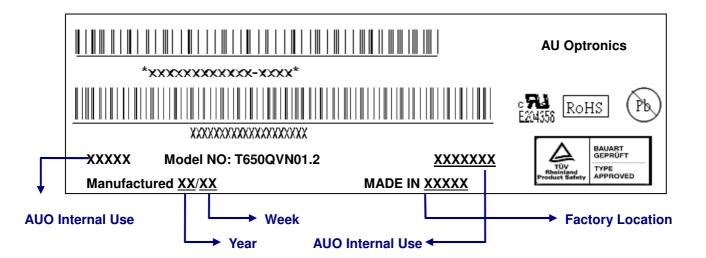


8. Packing

8-1 DEFINITION OF LABEL:

A. Panel Label:



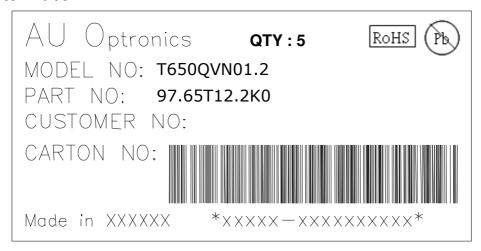


Green mark description

- (1) For Pb Free Product, AUO will add for identification.
- (2) For RoHs compatible products, AUO will add RoHS for identification.

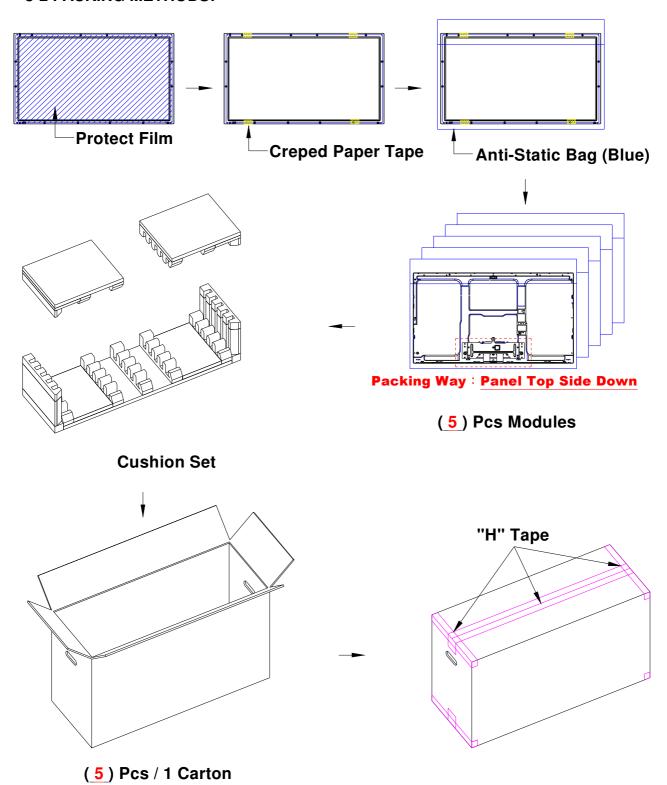
Note: The green Mark will be present only when the green documents have been ready by AUO internal green team. (definition of green design follows the AUO green design checklist.)

B. Carton Label:





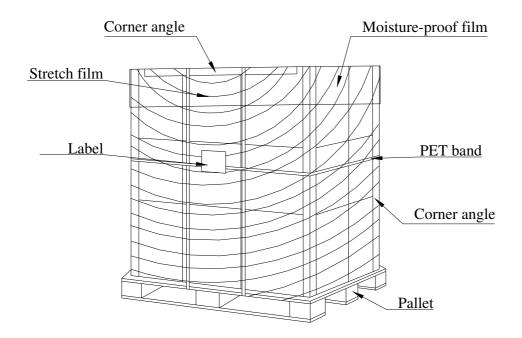
8-2 PACKING METHODS:





8-3 Pallet and Shipment Information

	Item		Packing Remark		
	цетт	Qty.	Dimension	Weight (kg)	Facking hemark
4	De aking DOV	E 1900/box	1050(1)*000(M)*050(1)	TDD	Box = TBD kg
'	Packing BOX	5 pcs/box	1050(L)*280(W)*650(H)	TBD	Cushion = TBD kg
2	Pallet	1	1140(L)*1060(W)*138(H)	16	
3	Boxes per Pallet		8 boxes/pallet		
4	Panels per Pallet				
	Pallet after packing	24	1140(L)*1060(W)*1438(H)	TBD	





9. PRECAUTIONS

Please pay attention to the followings when you use this TFT LCD module.

9-1 MOUNTING PRECAUTIONS

- (1) You must mount a module using holes arranged in four corners or four sides.
- (2) You should consider the mounting structure so that uneven force (ex. twisted stress) is not applied to module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
- (3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to the resist external force.
- (4) You should adopt radiation structure to satisfy the temperature specification.
- (5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter cause circuit broken by electro-chemical reaction.
- (6) Do not touch, push or rub the exposed polarizer with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth. (Some cosmetics are detrimental to the polarizer.)
- (7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach front/ rear polarizer. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
- (8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
- (9) Do not open the case because inside circuits do not have sufficient strength.

9-2 OPERATING PRECAUTIONS

- (1) The device listed in the product specification sheets was designed and manufactured for TV application
- (2) The spike noise causes the mis-operation of circuits. It should be lower than following voltage: V=±200mV(Over and under shoot voltage)
- (3) Response time depends on the temperature. (In lower temperature, it becomes longer..)
- (4) Brightness of CCFL depends on the temperature. (In lower temperature, it becomes lower.) And in lower temperature, response time (required time that brightness is stable after turned on) becomes longer.
- (5) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- (6) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- (7) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interface.

9-3 ELECTROSTATIC DISCHARGE CONTROL



Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wristband etc. And don't touch interface pin directly.

9-4 PRECAUTIONS FOR STRONG LIGHT EXPOSURE

Strong light exposure causes degradation of polarizer and color filter.

9-5 STORAGE

When storing modules as spares for a long time, the following precautions are necessary.

- (1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
- (2) The polarizer surface should not come in contact with any other object. It is recommended that they be stored in the container in which they were shipped.

9-6 HANDLING PRECAUTIONS FOR PROTECTION FILM

- (1) The protection film is attached to the bezel with a small masking tape. When the protection film is peeled off, static electricity is generated between the film and polarizer. This should be peeled off slowly and carefully by people who are electrically grounded and with well ion-blown equipment or in such a condition, etc.
- (2) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the bezel after the protection film is peeled off.
- (3) You can remove the glue easily. When the glue remains on the bezel or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normal-hexane.